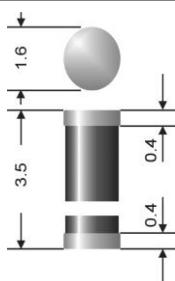


SGL 34-20...SGL 34-100



Surface mount diode

Schottky barrier rectifiers diodes

SGL 34-20...SGL 34-100

Forward Current: 0,5 A

Reverse Voltage: 20 to 100 V

Features

- Max. solder temperature: 260°C
- Plastic material has UL classification 94V-0
- One gray ring denotes "cathode" and "Schottky-Rectifier"
- The type numbers are noted only on the label on the reel

Mechanical Data

- Plastic case MiniMelf / DO-213AA / SOD 80
- Weight approx.: 0,04 g
- Terminals: plated terminals solderable per MIL-STD-750
- Mounting position: any
- Standard packaging: 2500 pieces per reel

1) Max. temperature of the terminals $T_T = 100^\circ\text{C}$

2) $I_F = 0,5 \text{ A}$, $T_j = 25^\circ\text{C}$

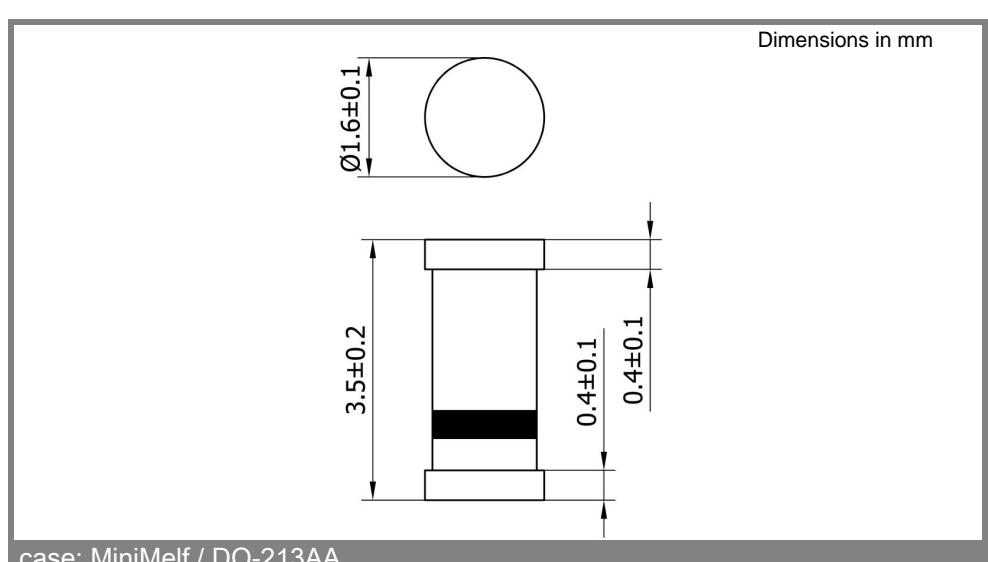
3) $T_A = 25^\circ\text{C}$

4) Mounted on P.C. board with 25 mm² copper pads at each terminal

| Type | Polarity color band | Repetitive peak reverse voltage | Surge peak reverse voltage | Maximum forward voltage $T_j = 25^\circ\text{C}$ $I_F = 0,5 \text{ A}$ | Maximum reverse recovery time $I_F = -\text{A}$ $I_R = -\text{A}$ $I_{RR} = -\text{A}$ $t_{rr} = \text{ns}$ |
|------------|---------------------|---------------------------------|----------------------------|---|---|
| | | V_{RRM} V | V_{RSM} V | $V_F^{(2)}$ V | |
| SGL 34-20 | - | 20 | 20 | 0,46 | - |
| SGL 34-30 | - | 30 | 30 | 0,46 | - |
| SGL 34-40 | - | 40 | 40 | 0,46 | - |
| SGL 34-50 | - | 50 | 50 | 0,6 | - |
| SGL 34-60 | - | 60 | 60 | 0,6 | - |
| SGL 34-90 | - | 90 | 90 | 0,65 | - |
| SGL 34-100 | - | 100 | 100 | 0,65 | - |

| Absolute Maximum Ratings | | $T_c = 25^\circ\text{C}$, unless otherwise specified | |
|--------------------------|--|---|------------------|
| Symbol | Conditions | Values | Units |
| I_{FAV} | Max. averaged fwd. current, R-load, $T_T = 75^\circ\text{C}$ | 0,5 | A |
| I_{FRM} | Repetitive peak forward current $f > 15 \text{ Hz}^1)$ | 6 | A |
| I_{FSM} | Peak fwd. surge current 50 Hz half sinus-wave ³⁾ | 10 | A |
| I_{rt} | Rating for fusing, $t < \text{ms}^3)$ | | A ² s |
| R_{thA} | Max. thermal resistance junction to ambient ⁴⁾ | 150 | K/W |
| R_{thT} | Max. thermal resistance junction to terminals | 70 | K/W |
| T_j | Operating junction temperature | -50...+150 | °C |
| T_s | Storage temperature | -50...+150 | °C |

| Characteristics | | $T_c = 25^\circ\text{C}$, unless otherwise specified | |
|-----------------|--|---|----------|
| Symbol | Conditions | Values | Units |
| I_R | Maximum leakage current, $T_j = 25^\circ\text{C}$; $V_R = V_{RRM}$ $T_j = 100^\circ\text{C}$; $V_R = V_{RRM}$ | <0,5 <5,0 | mA mA |
| C_J | Typical junction capacitance (at 1 MHz and applied reverse voltage of 6 V) | 30 | pF |
| Q_{rr} | Reverse recovery charge ($U_R = V$; $I_F = A$; $dI_F/dt = A/\text{ms}$) | - | μC |
| E_{RSM} | Non repetitive peak reverse avalanche energy ($I_R = \text{mA}$; $T_j = \text{°C}$; inductive load switched off) | - | mJ |



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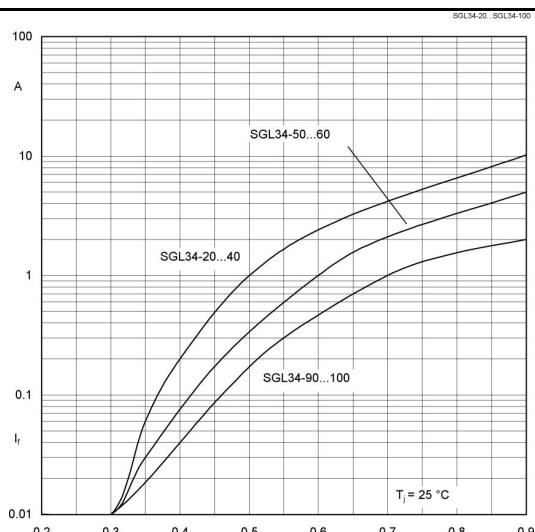


Fig. 1 Forward characteristic (typical values)

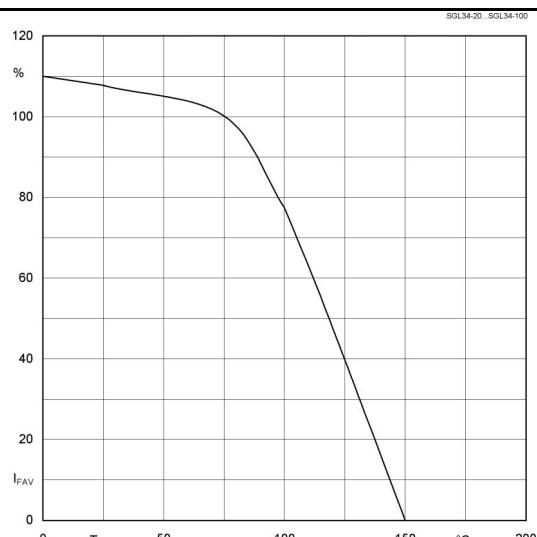


Fig. 2 Rated forward current vs. temp. of the terminals⁴⁾